

# SANYO Semiconductors

· Protection diode in

· Halogen free compliance

DATA SHEET

An ON Semiconductor Company

# EFC6601R — Lithium-ion battery charging and discharging switch

# Features

- 2.5V drive
- Common-drain type
- 2KV ESD HBM

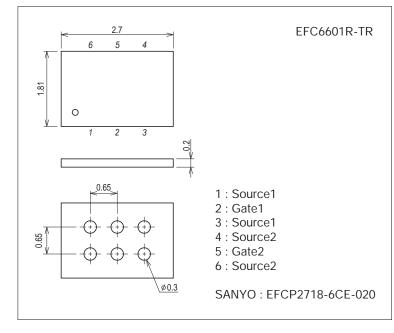
# **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Source-to-Source Voltage	VSSS		24	V
Gate-to-Source Voltage	VGSS		±12	V
Source Current (DC)	IS		13	Α
Source Current (Pulse)	ISP	PW≤10μs, duty cycle≤1%	60	A
Total Dissipation	PT	When mounted on ceramic substrate (5000mm <sup>2</sup> x0.8mm)	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Package Dimensions

unit : mm (typ) 7073-001

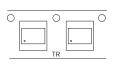


#### Product & Package Information

<ul> <li>Package</li> </ul>	: EFCP
• JEITA, JEDEC	: -

• Minimum Packing Quantity : 5,000 pcs./reel

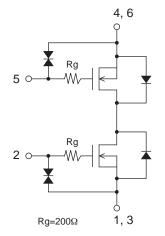
#### Marking



Taping Type : TR

MA o LOT No.

### **Electrical Connection**



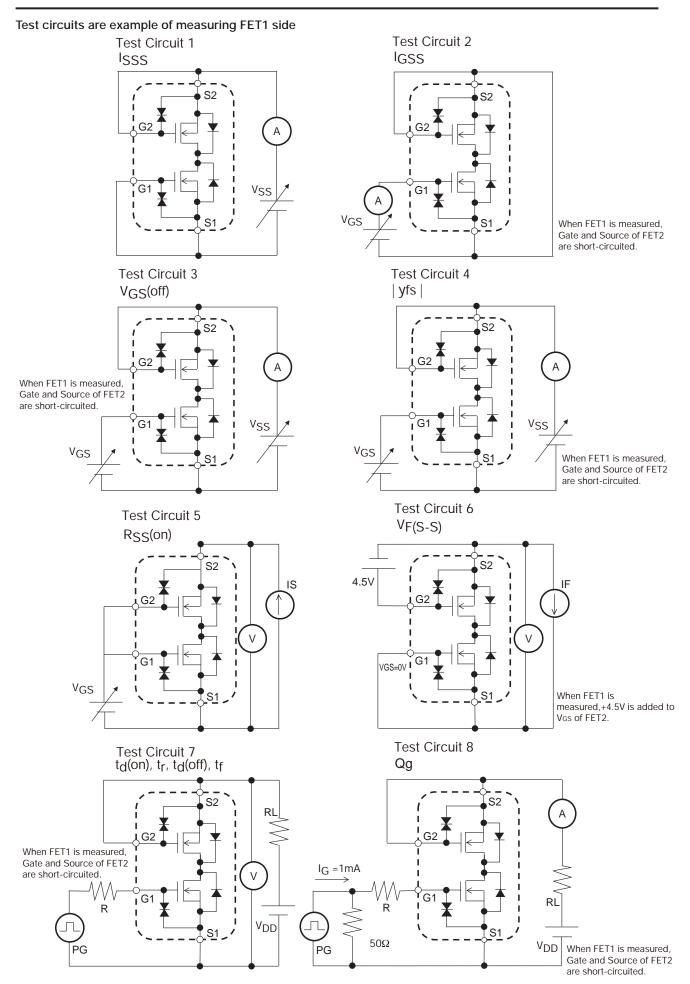
SANYO Semiconductor Co., Ltd. http://www.sanyosemi.com/en/network/

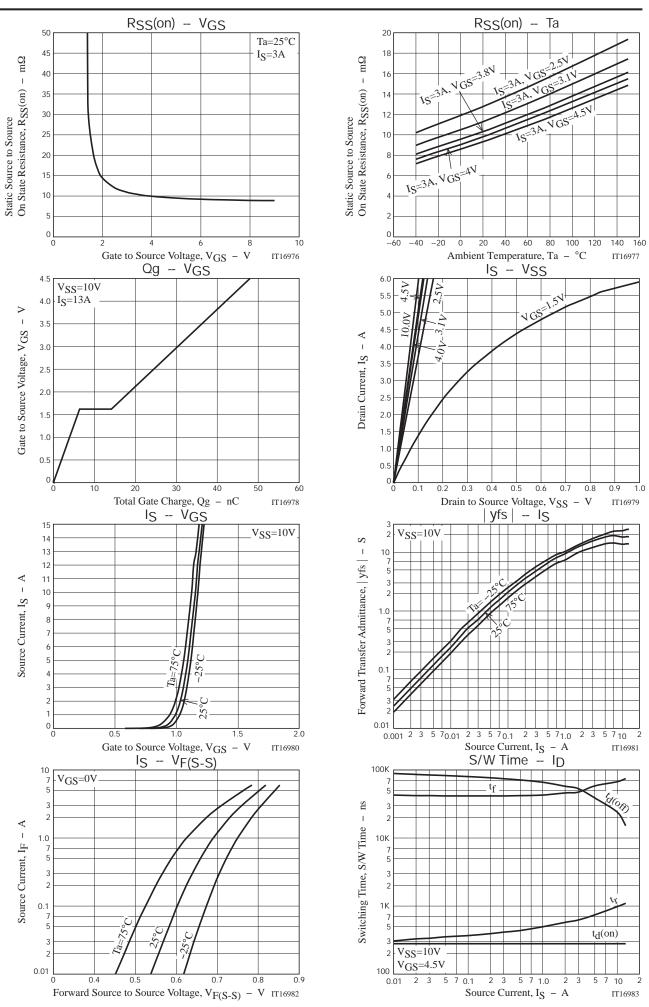
# Electrical Characteristics at Ta=25°C

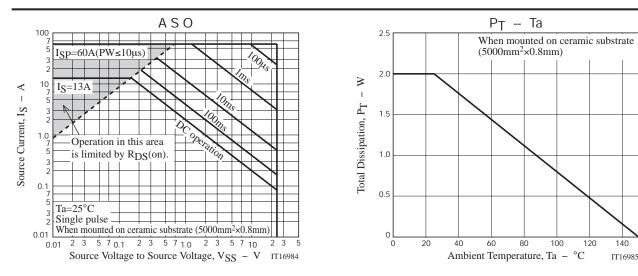
Deservation	Complete	Constitutions			Ratings		
Parameter	Symbol	Conditions		min	typ	max	Unit
Source-to-Source Breakdown Voltage	V(BR)SSS	IS=1mA, VGS=0V	Test Circuit 1	24			V
Zero-Gate Voltage Source Current	ISSS	VSS=20V, VGS=0V	Test Circuit 1			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS=±8V, VSS=0V	Test Circuit 2			±1	μΑ
Cutoff Voltage	VGS(off)	V <sub>SS</sub> =10V, I <sub>S</sub> =1mA	Test Circuit 3	0.5		1.3	V
Forward Transfer Admittance	yfs	VSS=10V, IS=3A	Test Circuit 4		15.5		S
Static Source-to-Source On-State Resistance	R <sub>SS</sub> (on)1	IS=3A, VGS=4.5V	Test Circuit 5	6.6	9.5	11.5	mΩ
	R <sub>SS</sub> (on)2	IS=3A, VGS=4.0V	Test Circuit 5	7.0	10	12	mΩ
	R <sub>SS</sub> (on)3	IS=3A, VGS=3.8V	Test Circuit 5	7.3	10.5	13	mΩ
	RSS(on)4	IS=3A, VGS=3.1V	Test Circuit 5	8.0	11.5	15	mΩ
	RSS(on)5	IS=3A, VGS=2.5V	Test Circuit 5	9.0	13	17	mΩ
Turn-ON Delay Time	t <sub>d</sub> (on)		Test Circuit 7		280		ns
Rise Time	tr				630		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	V <sub>DD</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>S</sub> =3A			53000		ns
Fall Time	tf	1			47000		ns
Total Gate Charge	Qg	V <sub>DD</sub> =10V, V <sub>GS</sub> =4.5V, I <sub>S</sub> =13A	Test Circuit 8		48		nC
Forward Source-to-Source Voltage	VF(S-S)	IS=3A, VGS=0V	Test Circuit 6		0.76	1.2	V

# **Ordering Information**

Device	Device Package		memo	
EFC6601R-TR	EFCP	5,000pcs./reel	Pb Free and Halogen Free	







100

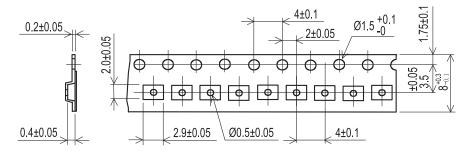
120

140

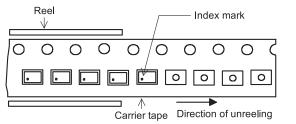
IT16985

## Taping Specification EFC6601R-TR

- 1. Taping Configuration
  - 1-1 .Carrier Tape Size (unit:mm)

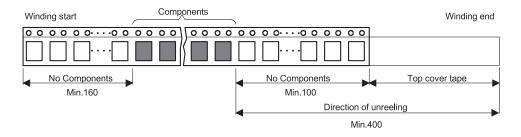


1-2 .Device Placement Direction

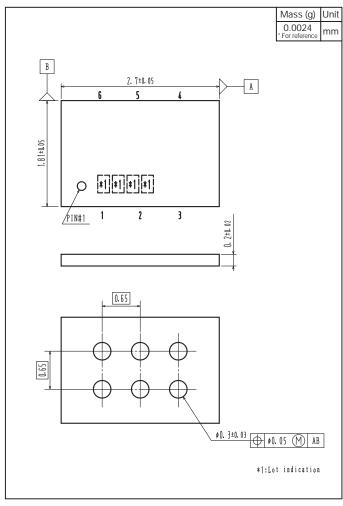


Packing type ····· TR

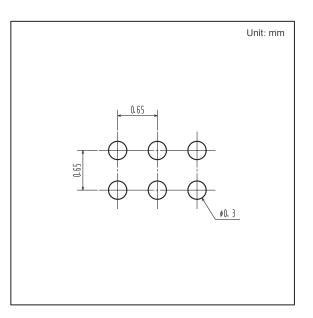
1-3 .Leader portion and Trailer portion (unit:mm)



# Outline Drawing EFC6601R-TR



# Land Pattern Example



Note on usage : Since the EFC6601R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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